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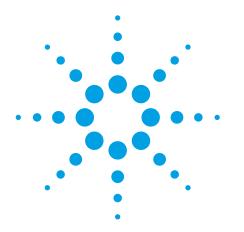
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Advanced Test Equipment Corp. www.atecorp.com 800-404-ATEC (2832)



Agilent N5183A MXG Microwave Analog Signal Generator

Data Sheet



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Agilent Technologies

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Definitions

Specification (spec): Represents warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ): Represents characteristic performance, which 80% of the instruments manufactured will meet. This data is not warranted, does not include measurement uncertainty, and is valid only at room temperature (approximately 25 °C).

Nominal (nom): The expected mean or average performance, or an attribute whose performance is by design, such as the 50 Ω connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas): An attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Note: All graphs contain measured data from several units at room temperature unless otherwise noted.

Frequency

Range

Option 520 Option 532 Option 540	100 kHz to 20 GHz 100 kHz to 31.8 GHz 100 kHz to 40 GHz
Minimum frequency	100 kHz ¹
Resolution	0.01 Hz
Phase offset	Adjustable in nominal 0.01° increments

Frequency switching speed^{2, 3}

Туре	Standard	Option UNZ	
SCPI mode	$\leq 5 \text{ ms}$	≤ 1.15 ms, 750 µs (typ)	
List/Step sweep mode	≤ 5 ms	≤ 900 µs, 600 µs (typ)	
Stability	± aging rate ± temperatu ± line voltaç	ire effects	
Internal time base reference oscillator aging rate	< ±1 ppm/y	r	
Temperature effects	± 1 ppm (ty	p) (0 to 55 °C)	
Line voltage effects	± 0.1 ppm (r	nom)	
Line voltage range	5% to10%	(nom)	
Reference output			
Frequency	10 MHz		
Amplitude	≥ +4 dBm (ı	nom) into 50 Ω load	
External reference input	F 1		
1	Fixed	Variable (Option 1ER)	
Input frequency	10 MHz	1 to 50 MHz	
Lock range	± 10 Hz		
Amplitude) dBm (nom)	
Impedance	50 Ω (nom)		
Digital sweep			
Operating modes	Step sweep	(equally or logarithmically spaced	
	frequency s		
		(arbitrary list of frequency steps)	
		nultaneously sweep amplitude. See	
•		ection for more detail.	
Sweep range	Within instrument frequency range		
Dwell time	100 μs to 100 s 2 to 65535 (step sweep)		
Number of points			
Ctan abonzo	1 to 1601 (li Linear or log		
Step change Triggering		gger key, external, timer, bus (GPIB, LAN, USB)	
шууешу	riee iuii, lli	yyer key, external, timer, bus (UFID, LAN, USB)	
Markers		ep mode, create up to 20 frequency markers	
Display		amplitude pulse	
Functions	M1 to cente	er, M1/M2 to start/stop, marker delta	
		_	

1. Performance below 250 kHz is unspecified, except as indicated.

Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater, and amplitude settled to within 0.2 dB.
 Specification does not apply when switching to or from frequencies < 500 kHz, when ALC level is

Specification does not apply when switching to or from frequencies < 500 kHz, when ALC level is
 -5 dBm for Option 540 or < 0 dBm for Option 520, or when frequency crosses 0.002, 0.02, 0.1, 2.0, 3.2, 20.0, 25.6, or 32.0 GHz.

Amplitude

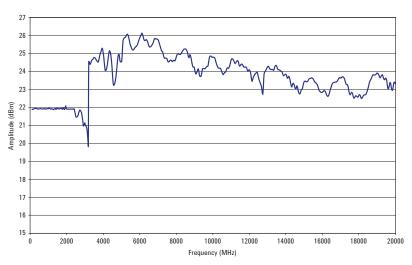
Maximum output power¹

Range	Standard ²	Option 1EA³
Option 520		
100 to 250 kHz	+11	+14
> 250 kHz to 3.2 GHz	+11	+15
> 3.2 to 20 GHz	+11	+18
Options 532 and 540		
100 to 250 kHz	+11	+14
250 kHz to 3.2 GHz	+7	+14
> 3.2 to 17 GHz	+7	+15
> 17 to 31.8 GHz	+7	+13
> 31.8 to 40 GHz	+7	+12

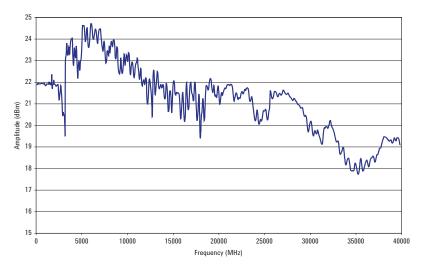
Minimum output power

Standard	–20 dBm
Option 1E1	-90 dBm⁴

Maximum available power Option 520 with Option 1EA (measured)



Maximum available power Option 540 with Option 1EA (measured)



Quoted specifications between 15 and 35 °C. Maximum output power typically decreases by 0.2 dB/ °C 1. for temperatures outside this range.

- Settable power +2 dB higher than specified. 2.
- Settable power +30 dBm. 3.
- 4. Settable to -130 dBm.

Resolution		 	_

0.01 dB

Step attenuator (Option 1E1)

0 to 115 dB in 5 dB steps

Amplitude hold range

-15 to maximum specified output power with step attenuator in 0 dB. Can be offset using Option 1E1 mechanical attenuator.

Amplitude switching speed^{1, 2}

Туре	
SCPI mode	2 ms (typ)
List/Step sweep mode	2 ms (typ)

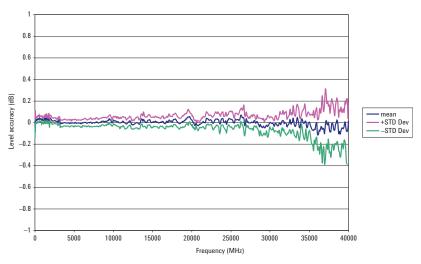
Absolute level accuracy [dB]^{3, 4}

Frequency range	−20 to < −10 dBm	–10 to +10 dBm	> +10 dBm
250 kHz to 2 GHz	±1.4	±0.6	±0.6
2 to 20 GHz	±1.3	±0.9	±0.9
20 to 40 GHz	±1.3	±0.9	±1.0

Absolute level accuracy with Option 1E1 (dB)⁴

Frequency range	–90 to < –75 dBm	-75 to < -10 dBm	–10 to +10 dBm	> +10 dBm
250 kHz to 2 GHz	±1.4	±0.7	±0.6	±0.6
2 to 20 GHz	±1.6	±1.0	±0.9	±0.9
20 to 40 GHz	±2.0	±1.1	±0.9	±1.0

Measured level accuracy Options 520 & 540 at -90 dBm



^{1.} Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB.

^{2.} Specification does not apply when switching from and to amplitudes where ALC levels are < -5 dBm for Option 540 or < 0 dBm for Option 520.

^{3.} Level accuracy applies from -20 dBm to maximum output power between 15 °C and 35 °C.

^{4.} For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/degree C for frequencies ≤ 4.5 GHz and 0.02 dB/degree C for frequencies > 4.5 GHz. For instruments with Type-N connectors (Option 1ED), specifications are degraded typically 0.2 dB above 18 GHz. Specifications do not apply above the maximum specified power.

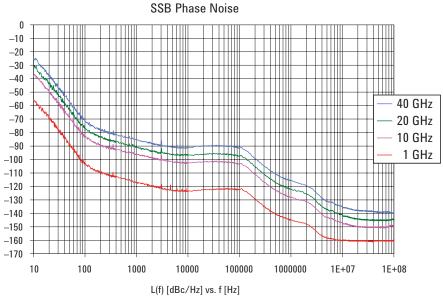
Temperature stability	0.01 dB/°C (typ) for temperatures < 20 °C or > 30 °C		
User flatness correction			
Number of points	2 to 1601		
Number of tables	10000 maximum; dependent on available free memory in in instrument		
Entry modes	USB/LAN direct power meter control, LAN to GPIB and USB to GPIB, remote bus and manual USB/GPIB power meter control		
SWR	100 kHz to 20 GHz 1.6:1 (typ)		
	> 20 to 40 GHz 1.8:1 (typ)		
Leveling modes	Internal, external detector, ALC off, search		
External detector leveling ¹			
Range	-0.2 mV to -0.5V (nom)		
Bandwidth	10 kHz (typ)		
Digital sweep modes			
Operating modes	Step sweep (evenly spaced amplitude steps)		
	List sweep (arbitrary list of amplitude steps)		
	Can also simultaneously sweep frequency. See frequency section for more detail.		
Sweep range	Within instrument amplitude range		
Dwell time	100 μ s to 100 s		
Number of points	2 to 65535 (step sweep)		
	1 to 1601 (list sweep)		
Step change	Linear		
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)		

1. Not intended for pulsed operation.

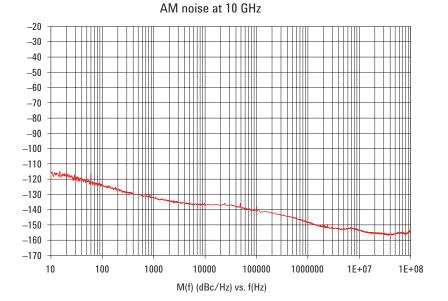
Spectral Purity

Single sideband phase noise (at 20 kHz offset from carrier)

Frequency range	dBc/Hz	dBc/Hz (typ)
250 kHz to < 250 MHz	-113	-116
250 to < 375 MHz	-125	-128
375 to < 750 MHz	-119	-122
750 MHz to < 1.5 GHz	-113	-116
1.5 to < 3.0 GHz	-107	-110
3.0 to < 6.0 GHz	-101	-104
6.0 to < 12.0 GHz	-95	-98
12.0 to < 24.0 GHz	-89	-92
24.0 to 40.0 GHz	-83	-86







Residual FM (CW mode, 0.3 to 3 kHz bandwidth, CITT, RMS) < N*5Hz (typ)

CW mode at +10 dBm or maximum specified output power, whichever is lower for offsets > 10 MHz

Broadband noise

> 2 to 20 GHz > 20 to 40 GHz

0.25 to 10 GHz 10 to 20 GHz 20 to 40 GHz

Harmonics (dBc)¹ 250 kHz to 2 GHz -28 (-30 typ)

-54 (-60 typ) -56 (typ)

-145 dBc/Hz (typ)

-135 dBc/Hz (typ)

-130 dBc/Hz (typ)

Non-harmonics (dBc)^{1, 2}

250 kHz to 250 MHz	-62 (-89 typ)
> 250 to 375 MHz	-68 (-86 typ)
> 375 to 750 MHz	–57 (–74 typ)
> 750 MHz to 1.5 GHz	-54 (-70 typ)
> 1.5 to 3.2 GHz	-54 (-68 typ)
> 3.2 to 6 GHz	-47 (-63 typ)
> 6 to 12 GHz	-41 (-57 typ)
> 12 to 24 GHz	(—50 typ)
> 24 to 40 GHz	(—45 typ)

Subharmonics (dBc)¹

250 kHz to 1.5 GHz	None
> 1.5 GHz to 20 GHz	-53
> 20 to 40 GHz	-50

^{1.} CW mode at +10 dBm or maximum specified output power, whichever is lower.

Non-harmonics specifications apply to units with serial numbers ending with 49060000 or greater. For units with lower serial numbers, refer to the archive section at the end of this document.

Analog Modulation

Frequency bands¹

Frequency	N
100 kHz to < 250 MHz	1
250 to < 375 MHz	0.250
375 to < 750 MHz	0.500
750 to < 1.5 GHz	1
1.5 to < 3.0 GHZ	2
3.0 to < 6.0 GHz	4
6.0 to < 12.0 GHz	8
12.0 to < 24.0 GHz	16
24.0 to 40 GHz	32

Frequency modulation (Option UNT)

Maximum deviation	N x 10 MHz (nom)
Resolution	0.1% of deviation or 1 Hz, whichever is
	greater (nom)
Deviation accuracy	< ± 2% + 20 Hz
1 kHz rate, deviation is N x 50 kHz	

Modulation frequency response (at 100 kHz deviation)

	1 dB bandwid	th	3 dB bandwidth
DC coupled	DC to 3 MHz (no	om)	DC to 7 MHz (nom)
AC coupled	5 Hz to 3 MHz (nom)	5 Hz to 7 MHz (nom)
Carrier frequency accurac relative to CW in DCFM Distortion 1 kHz rate, deviation is Sensitivity when using external input	, < N x 50 kHz	< ±0.06% of < 0.4%	set deviation + (N x 1 Hz)² f set deviation + (N x 1 Hz) (ty r indicated deviation (nom)

^{1.} N is a factor used to help define frequency and phase modulation specifications within the document.

^{2.} Specification valid for temperature changes of less than $\pm\,5^{\circ}\,C$ since last DCFM calibration.

^{3.} Typical performance immediately after a DCFM calibration.

Phase modulation (Option UNT)

Modulation deviation and frequency response:

	Max deviation	3 dB bandwidth
Nominal bandwidth	N x 5 radians (nom)	DC to 1 MHz (nom)
High bandwidth mode	N x 0.5 radians (nom)	DC to 4 MHz (nom)
Resolution	0.1% of deviation	
Deviation accuracy 1 kHz rate, normal band).01 rad (typ)
Distortion	< 0.2% (typ)	
1 kHz rate, deviation no	ormal bandwidth mode	
Sensitivity when using external input	+1V peak fo	r indicated deviation (nom)

Amplitude modulation¹ (Option UNT)

AM Depth	Linear	Exponential
Maximum settable	90%	20 dB
Resolution	0.1% of depth (nom)	0.01 dB (nom)
Accuracy (1 kHz rate)	< ±4% of setting	<±(4% of setting
	+ 1% (typ)	+ 0.2 dB) (typ)

Modulation rate (3 dB bandwidth, 30%	depth)
DC coupled	0 to 10 kHz (typ)
AC coupled	5 Hz to 10 kHz (typ)
Distortion (1 kHz rate, 30% depth)	< 2.0% (typ)
Sensitivity when using	
external input	+1V peak for indicated depth (nom)

^{1.} AM is specified at carrier frequencies > 2 MHz, ALC on, and when AM envelope does not exceed max power or go below -15 dBm for Option 520 or -20 dBm for Option 540.

Pulse modulation¹ **(Opt** On/

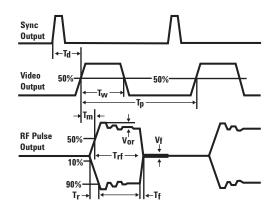
(Option UNU)	
On/Off ratio	> 80 dB (typ) ²
Rise time	< 50 ns (typ)
Fall time	< 50 ns (typ)
Minimum width	
ALC on	≥ 2 µs (typ)
ALC off	≥ 500 ns (typ)
Resolution	20 ns (nom)
Pulse repetition frequency	
ALC on	DC to 500 kHz
ALC off	DC to 2 MHz
Level accuracy	< 1 dB (typ)
(relative to CW, ALC on or off)	
Video feedthrough	< 350 mV (typ)
Pulse overshoot	< 15% (nom)
Pulse compression	15 ns (typ)
Pulse delay	
RF delay (video to RF output)	10 ns (nom)
Video delay (ext input to video)	30 ns (nom)
External input	
Input impedance	50 ohm (nom)
Level	+1 Vpeak = ON (nom)
Internal pulse generator	
Modes	Free-run, square, triggered, adjustable doublet,
	trigger doublet, gated, and external pulse
Square wave rate	0.1 Hz to 10 MHz, 0.1 Hz resolution (nom)
Pulse period	500 ns to 42 seconds (nom)
Pulse width	500 ns to pulse period – 10 ns (nom)
Resolution	10 ns (nom)
Adjustable trigger delay	 pulse period + 10 ns to pulse period to pulse width –10 ns
Settable delay	Free run –3.99 to 3.97 µs
Triggered	0 to 40 s
Resolution	10 ns (nom)
(delay, width, period)	
Pulse doublets	
1st pulse delay	0 to 42 s – pulse width – 10 ns
(relative to sync out)	
1st pulse width	500 ns to 42 s – delay – 10 ns
2nd pulse delay	0 to 42 s – (delay1 + width ²) – 10 ns
(relative to pulse 1)	
2nd pulse width	20 ns to 42 s – (delay1 + delay ²) – 10 ns

Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.
 Applies to power levels > -5 dBm for Option 1E1.

Narrow pulse modulation¹ (Option UNW)

	500 MHz to 3.2 GHz	Above 3.2 GHz
On/Off ratio	> 80 dB (typ)	> 80 dB (typ)
Rise/Fall times (Tr, Tf)	< 10 ns (7 ns)	< 10 ns (7 ns)
Minimum pulse width		
Internally leveled	≥ 2 us	≥ 2 us
ALC off ²	≥ 20 ns	≥ 20 ns
Repetition frequency		
Internally leveled	10 Hz to 500 kHz	10 Hz to 500 kHz
ALC off ²	DC to 5 MHz	DC to 10 MHz
Level accuracy relative to CW		
Internally leveled	< ±1.0 dB (typ)	< ±1.0 dB (typ)
ALC off ²	±1.0 dB (typ)	±1.0 dB (typ)
Width compression	< 5 ns (typ)	< 10 ns (typ)
RF width relative to video out		
Video feed-through ³	< 300 mV (typ)	< 10 mV (typ)
Video delay -	30 ns (nom)	30 ns (nom)
ext input to video		
RF delay -video to	10 ns (nom)	20 ns (nom)
RF output		
Pulse overshoot	< 15% (nom)	< 15% (nom)
Input level	+1 Vpeak = RF On	+1 Vpeak = RF On
Input impedance	50 Ω (nom)	50 Ω (nom)

Td Video delay (variable) Tw Video pulse width (variable) Tp Pulse period (variable) Tm RF delay Trf RF pulse width Tf RF pulse fall time Tr RF pulse rise time Vor Pulse overshoot Vf Video feedthrough



^{1.} Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.

^{2.} With power search on.

^{3.} Applies to power levels < +10 dBm.

Internal analog modulation source (Option UNT)

Waveform Rate range Resolution Frequency accuracy

Sine 0.1 Hz to 2 MHz (tunable to 3 MHz) 0.1 Hz Same as RF reference source (nom)

External modulation inputs

(Requires Option UNT) Modulation types Input impedance

FM, AM, phase mod, pulse mod 50 Ω (nom)

Simultaneous modulation¹

All modulation types (FM, AM, ϕ M and pulse modulation) may be simultaneously enabled except: FM and phase modulation can not be combined; two modulation types can not be simultaneously generated using the same modulation source. For example, AM and FM can run concurrently and will modulate the output RF. This is useful for simulating signal impairments.

^{1.} If AM or pulse modulation are on, then phase and FM specifications do not apply.

General Characteristics

Remote programming

Remote programming	
Interfaces	GPIB IEEE-488.2, 1987 with listen and talk LAN 100BaseT LAN interface, LXI class C compliant USB Version 2.0
Control languages	SCPI Version 1997.0
Compatibility languages supporting Agilent Technologies	a subset of common commands 8360 series, E8247C, E8257C, E8257D, E8241A, E8244A, E8251A, E8254A, E4428C, E4438C, E8267C/D, 8662A, 8663A, 83711B, 83712B, 83731B, 83732B, 83751B, 83752B, 8340B, 8341B
Power requirements	100 to 120 VAC, 50 to 60 Hz and 400 Hz 220 to 240 VAC, 50 to 60 Hz 250 W maximum
Operating temperature range	0 to 55 °C
Storage temperature range	-40 to 70 °C
Operating and storage altitude	15,000 feet
Environmental stress	Samples of this product have been type tested in accordance with the Agilent Environmental Test Manual and verified to be robust against the environmental stresses of Storage, Transportation and End-use; those stresses include but are not limited to temperature, humidity, shock, vibration, altitude and power line conditions. Test Methods are aligned with IEC 60068-2 and levels are similar to MIL-PRF-28800F Class 3.
Safety	Complies with European Low Voltage Directive 73/23/EEC, amended by 93/68/EEC • IEC/EN 61010-1 • Canada: CSA C22.2 No. 61010-1 • USA: UL 61010-1
EMC	Complies with European EMC Directive 89/336/ EEC, amended by 93/68/EEC • IEC/EN 61326 • CISPR Pub 11 Group 1, class A • AS/NZS CISPR 11:2002 • ICES/NMB-001
Memory	Memory is shared by instrument states, sweep list files, and other files. There is 512 MB of flash memory available in the N5181A MXG. Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved.

Security (Option 006)	Memory sanitizing, memory sanitizing on power on, and display blanking.
Self test	Internal diagnostic routines test most modules in a preset condition. For each module, if its node voltages are within acceptable limits, the module "passes" the test.
Weight	≤ 13.8 kg (30 lb.) net, ≤ 28.4 kg (62 lb.) shipping
Dimensions	103 mm H x 426 mm W x 432 mm L (4.07 in H x 16.8 in W x 17 in L)
Recommended calibration cycle	24 months
ISO compliant	The Agilent N5181A MXG is manufactured in an ISO-9001 registered facility in concurrence with Agilent Technologies' commitment to quality.
Front panel connectors ¹	
RF output Option 520	Output impedance 50 Ω (nom) Precision APC-3.5 male, or Type-N with Option 1ED
Option 532/540	Precision 2.4 mm male; plus 2.4 – 2.4 mm and 2.4 – 2.9 mm female adapters
Maximum reverse power USB 2.0	0.5 W, 0 Vdc Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument. Also used with U2000 series USB average power sensors. For a current list of supported memory sticks, visit www.agilent.com/find/MXG, click on Technical Support, and refer to FAQs: WaveformDownloads and Storage.
Rear panel connectors ¹	
RF output	Outputs the RF signal via a precision N type
(Option 1EM) Sweep out	female connector. Generates output voltage, 0 to +10 V when the signal generator is sweeping. This output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode. Output impedance < 1 Ω , can drive 2k Ω . Damage levels are ±15 V.
AM	External AM input. Nominal input impedance is 50 Ω . Damage levels are ± 5 V.
FM	External FM input. Nominal input impedance is 50 $\Omega.$ Damage levels are ± 5 V.
Pulse	External pulse modulation input. This input is TTL and CMOS compatible. Low logic levels are 0 V and high logic levels are +1 V. Nominal input impedance is 50 Ω . Input damage levels are ≤ -0.3 V and $\geq +5.3$ V.

1. All connectors are BNC unless otherwise noted.

Trigger in	This high impedance input accepts TTL and CMOS level signals for triggering point-to-point
	in sweep mode. Damage levels are ≤ -0.3 V and
	$\geq +5.3$ V.
Trigger out	Outputs a TTL and CMOS compatible level
55	signal for use with sweep mode. The signal is
	high at start of dwell, or when waiting for point
	trigger in manual sweep mode; low when dwell
	is over or point trigger is received. This output
	can also be programmed to indicate when the
	source is settled, pulse synchronization, or pulse
	video. Nominal output impedance is 50 ohms.
	Input damage levels are ≤ -0.3 V and $\geq +5.3$ V.
Reference input	Accepts a 10 MHz reference signal used to
	frequency lock the internal timebase. Option 1ER
	adds the capability to lock to a frequency from
	1 MHz to 50 MHz. Nominal input level –3.5 to
	+20 dBm, impedance 50 Ω.
10 MHz out	Outputs the 10 MHz reference signal used by
	internal time base. Level is nominally +3.9 dBm.
	Nominal output impedance 50 Ω . Input damage
	level is +16 dBm.
USB 2.0	The USB connector provides remote programming
	functions via SCPI.
LAN (100 BaseT)	The LAN connector provides the same SCPI
	remote programming functionality as the GPIB
	connector. The LAN connector is also used to
	access the internal web server and FTP server.
	The LAN supports DHCP, sockets SCPI, VXI-11
	SCPI, connection monitoring, dynamic host name
	services, TCP keep alive. This interface is LXI
	class C compliant.
GPIB	The GPIB connector provides remote
	programming functionality via SCPI.
ALC input	This female BNC connector is used for negative
	external detector leveling.
	Input impedance 100 k Ω (nominal)
	Signal levels –0.2 mV to –0.5 V
7	Damage levels ≤ -12 V and ≥ 1 V
Z-axis output	This female BNC connector supplies a +5 V
	(nominal) level during retrace and band switch
	intervals of a step or list sweep. During step or
	list sweep, this connector supplies a –5 V (nominal) level when the RF frequency is at a
	marker frequency and intensity marker mode is
	on. The load impedance should be $\geq 5 \text{ k}\Omega$.
	on. The load impedance should be $\geq 3 \text{ kM}$.

Ordering Information

N5183A MXG microwave analog signal generator

Frequency

- 520 Frequency range from 100 kHz to 20 GHz
- 532 Frequency range from 100 kHz to 31.8 GHz
- 540 Frequency range from 100 kHz to 40 GHz

Performance enhancements

- UNZ Fast frequency switching
- 1E1 Step attenuator
- 1EA High power
- UNU Pulse modulation
- UNW Narrow pulse modulation
- UNT AM, FM, phase modulation
- 006 Instrument security
- 1ER Flexible reference input (1-50 MHz)
- 1EM Move RF output to rear panel
- 1ED Type N RF output connector

Accessories

- 1CM Rackmount kit
- 1CN Front handle kit
- 1CP Rackmount and front handle kit
- 1CR Rack slide kit
- AXT Transit case

Archive

Non-harmonics (dBc)

	- /
(For serial numbers < 49060000)	
250 kHz to 250 MHz	-54 (-89 typ)
> 250 to 375 MHz	-61 (-86 typ)
> 375 to 750 MHz	–55 (–74 typ)
> 750 MHz to 1.5 GHz	-48 (-70 typ)
> 1.5 to 3.2 GHz	-47 (-68 typ)
> 3.2 to 6 GHz	-40 (-63 typ)
> 6 to 12 GHz	–33 (–57 typ)
> 12 to 24 GHz	-50 (typ)
> 24 to 40 GHz	—45 (typ)

Related Literature

Application literature

RF Source Basics, a self-paced tutorial (CD-ROM), literature number 5980-2060E

Product literature

Agilent MXG Signal Generator, Configuration Guide, literature number 5989-5485EN

See the Agilent MXG web page for the latest information. Get the latest news, product and support information, application literature, firmware upgrades and more at **www.agilent.com/find/MXG**



www.agilent.com/find/emailupdates Get the latest information on the products and applications you select.

LXI

www.lxistandard.org

LXI is the LAN-based successor to GPIB, providing faster, more efficient connectivity. Agilent is a founding member of the LXI consortium.

Agilent Channel Partners

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Remove all doubt

Our repair and calibration services will get your equipment back to you, performing like new, when promised. You will get full value out of your Agilent equipment through-out its lifetime. Your equipment will be serviced by Agilent-trained technicians using the latest factory calibration procedures, automated repair diagnostics and genuine parts. You will always have the utmost confidence in your measurements. For information regarding self maintenance of this product, please contact your Agilent office.

Agilent offers a wide range of additional expert test and measurement services for your equipment, including initial start-up assistance, onsite education and training, as well as design, system integration, and project management.

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